Westerman, Hattori, Daniels & Adrian, LLP

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

"SUBSTRATE WITH ORGANIC THIN FILM, TRANSISTOR USING SAME, AND METHODS FOR PRODUCING THOSE"

AND	METHODS FOR PRODUCT	IG THOSE"	•		
the specification	on of which is attached hereto un	less the following is ch	ecked		
⊠ was filed o International A	nas United States Applica Application Number <u>PCT / JP20</u>	tion Number and 005 / 006199 and was a	i was filed on 24 March, 200 mended on 24 January, 200	<u>5</u> as PCT <u>6</u> (if applicable).	
I hereby state t claim	that I have reviewed and understands, as amended by any amendment	and the contents of the a	above-identified specification,	including the	
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pa	tentability as defined in Title	37, Code of Federal	
for patent or in	foreign priority benefits under T ventor's certificate listed below ificate having a filing date before	and have also identified	l below any foreign application	eign application(s) n for patent or	
(Tink out on Constant				Priority Claimed	
(List prior foreign applications. See note A)	2004-088077 (Number)	Japan (Country)	24 March, 2004 (Day/Month/Year Filed)	⊠ Yes □ No	
	(rumbor)	(Coming)	(Day/World) Teal Fried)	☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No	
	(Number)	(Country)	(D. 04 d 97 E)	☐ Yes ☐ No	
(See note B)	See attached list for additional	(Country)	(Day/Month/Year Filed)		
I hereby claim insofar as the s in the manner information wh	the benefit under Title 35, Units subject matter of each of the clair provided by the first paragraph of iich is material to patentability a secame available between the fili	ed States Code, § 120 on sof this application is of Title 35, United States defined in Title 37, Co	f any United States application of the prior United States application of the prior United States and I acknowledge of Federal Regulations.	ted States application e the duty to disclose	
(List prior U.S. Applications)			Status Patented Pending Abandoned		
	(Application Serial No.)	(Filing Date)	Patented _ Pend	ing Abandoned	
	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned		
	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned		
	(Application Serial No.)	(Filing Date)	Patented Pend	ing Abandoned	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

see note C)	Full name of sole or first inventor (given name, family name)		Hideomi KOINUMA					
	Inventor's signature	Hisami Wound	Date September 13, 2006					
	Residence	Tokyo, Japan	Citizenship	Japan				
	Post Office Address	3-47-8, Ogikubo, Suginami-ku, Toky	o 167-0051 Japan					
		nventor (given name, family name)	Kenji ITAKA					
	Inventor's signature	Kenji Stoka	Date Septemb	er 13, 2006				
	Residence	Kanagawa, Japan	Citizenship	Japan				
	Post Office Address	2-17-41, Utsukushigaoka, Aoba-ku,	Yokohama-shi, Kanaga	wa 225-0002 Japan				
	Full and a Cabination		B#:4 37	AMACHIDO				
	Inventor's signature	ventor (given name, family name)	Mitsugu YAMASHIRO Date September 13, 2006					
	Residence		Citizenship					
	Post Office Address	Kanăgawa, Japan 21-13-S205, Shouhuudai, Aoba-ku, Y	_ •	Japan 227 0067 J				
	1 001 011100 1100100	wa 227-006/ Japan						
	Full name of fourth in Inventor's signature	nventor (given name, family name)	Date					
	Residence		Citizenship					
	Post Office Address							
	Full name of fifth inv	Full name of fifth inventor (given name, family name)						
	Inventor's signature	,,,,,	Date					
	Residence		Citizenship					
	Post Office Address							
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	Full name of sixth inventor (given name, family name) Inventor's signature		Date					
	Residence		Citizenship					
	Post Office Address							
								